

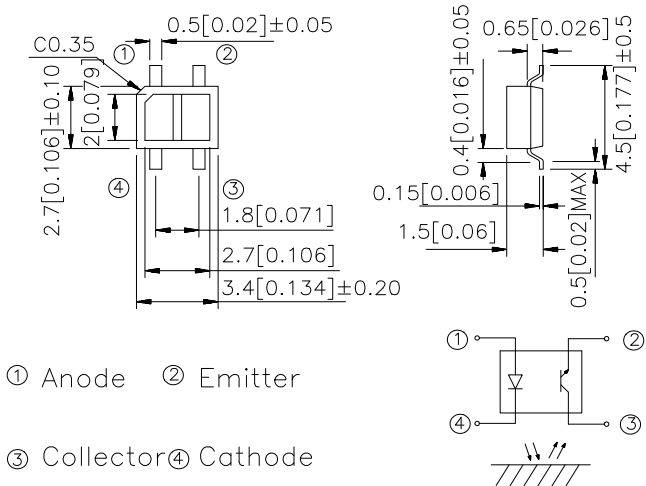
SUBMINIATURE, HIGH SENSITIVITY PHOTOINTERRUPTER

*Features

- Compact and thin.
- Visible light cut-off type.
- High sensitivity.
- Package:1000pcs/Reel.
- Moisture sensitivity level : level 4.
- RoHS Compliant.

*Applications

- Cassette tape recorders,VCRs.
- Floppy disk drives.
- Various microcomputerized control equipment.



UNIT : MM[INCH]
TOLERANCE :±0.25[± 0.01] UNLESS OTHERWISE NOTED.

*Absolute Maximum Ratings

Parameter		Symbol	Rating	Unit
Input	Forward current	I _F	50	mA
	Reverse voltage	V _R	6	V
	Power dissipation	P _D	75	mW
	Peak Forward Current (Pulse Width ≤100uS, Duty Cycle =1%)	I _{FP}	1	A
Output	Collector-emitter voltage	V _{CEO}	35	V
	Emitter-collector voltage	V _{ECO}	6	V
	Collector current	I _C	20	mA
	Collector power dissipation	P _C	75	mW
Operating temperature		Topr	-25~+85	°C
Storage temperature		Tstg	-40~+100	°C
soldering temperature (1/16 inch from body for 5 seconds)		Tsol	260	°C



■ Electro-optical Characteristics

Parameter		Symbol	Conditions	Min.	TYP.	Max.	Unit
Input	Forward Voltage	V_F	$I_F=20\text{mA}$	1.0	1.2	1.5	V
	Reverse Current	I_R	$V_R=6\text{V}$	-	-	10	μA
	Peak Wavelength	λ_P	$I_F=20\text{mA}$	-	940	-	nm
Output	Collector Dark Current	I_{CEO}	$V_{CE}=20\text{V}$	-	10^{-9}	10^{-7}	A
Transfer characteristics	*1 Collector Current	I_C	$V_{CE}=2\text{V}$ $I_F=4\text{mA}$	10	-	400	μA
	*2 Leak Current	I_{LEAK}	$V_{CE}=2\text{V}$ $I_F=4\text{mA}$	-	-	0.1	μA
	Response time	Rise time	$V_{CE}=2\text{V}$ $I_C=100\mu\text{A}$ $R_L=1\text{K}\Omega, d=1\text{mm}$	-	20	100	μsec
		Fall time		-	20	100	μsec

*1 The condition and arrangement of the reflective object are shown below.

*2 Without reflective object.

■ Classification table of radiant flux

BIN CODE	E	F	G
$I_C (\mu\text{A})$	10~120	100~250	200~400

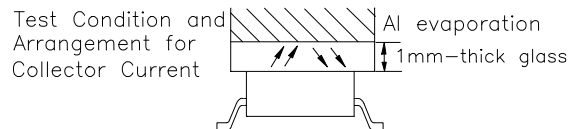


Fig. 1 Forward Current vs. Forward Voltage

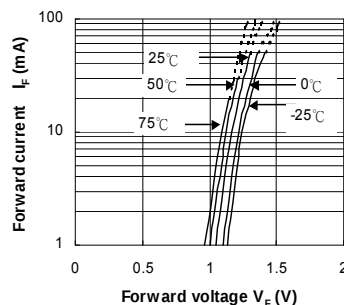


Fig. 2 Collector Current vs. Forward Current

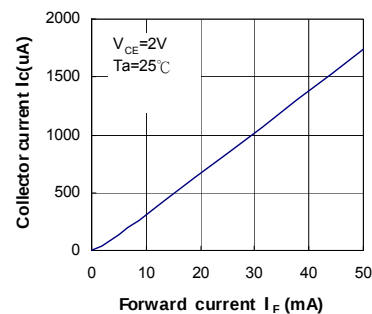


Fig. 3 Collector Current vs. Collector-emitter Voltage

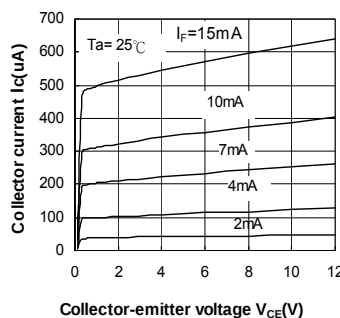


Fig. 4 Relative Collector Current vs. Ambient Temperature

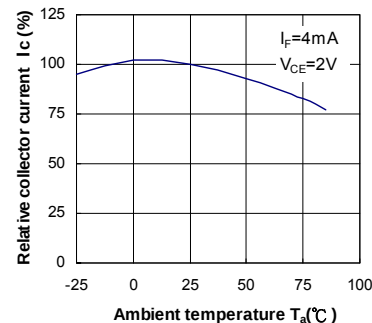
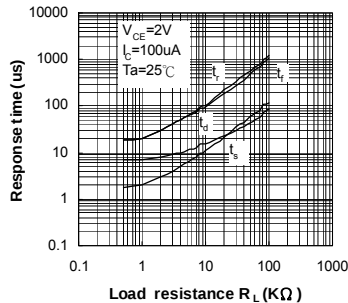


Fig. 5 Response Time vs. Load Resistance



Test Circuit for Response Time

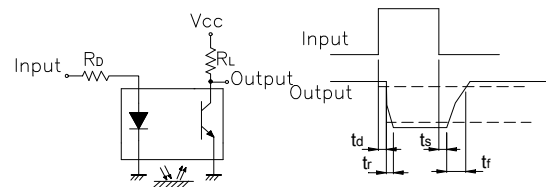


Fig. 6 Collector Dark Current vs. Ambient Temperature

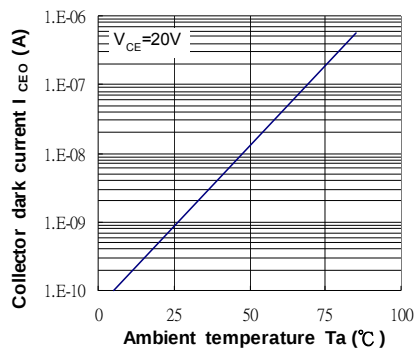


Fig. 7 Relative Collector Current vs. Distance between Sensor and Al Evaporation Glass

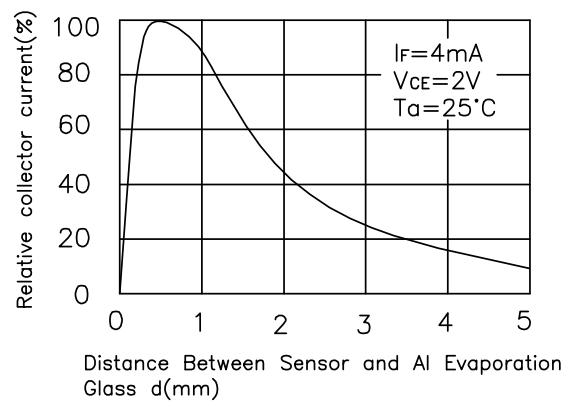


Fig. 8 Relative Collector Current vs. Card Moving Distance (1)

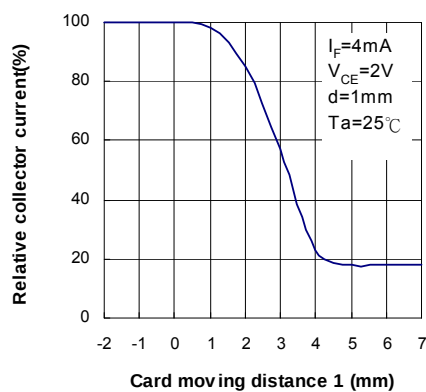
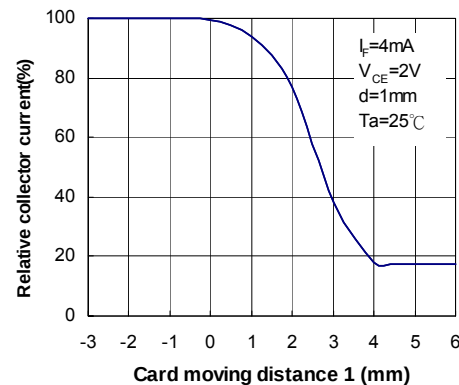


Fig. 9 Relative Collector Current vs. Card Moving Distance (2)



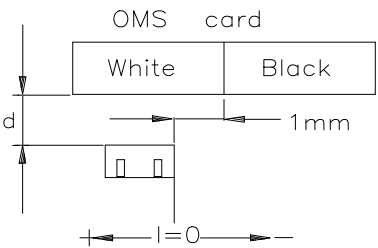
Test Condition for Distance & Detecting Position Characteristics

Correpond to Fig. 7



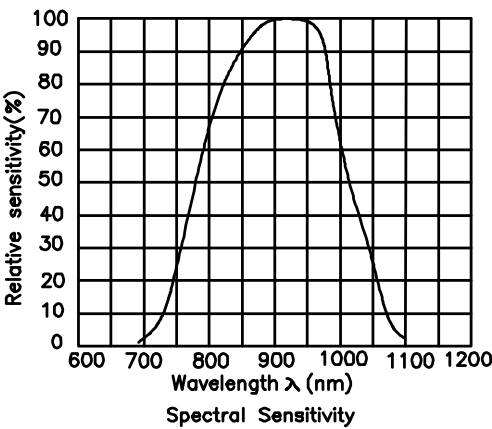
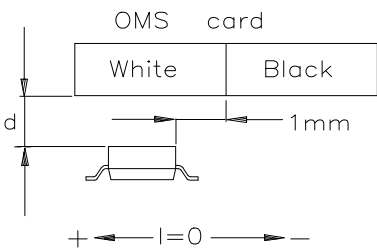
Correpond to Fig. 8
Test condition

$I_F = 4\text{mA}$
 $V_{CE} = 2\text{V}$
 $d = 1\text{mm}$

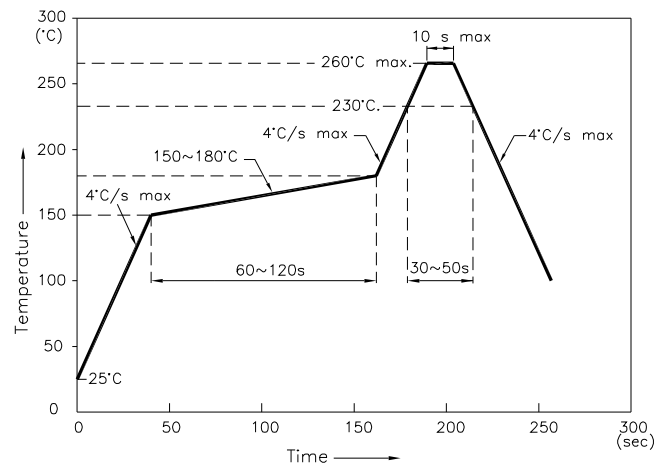


Correpond to Fig. 9
Test condition

$I_F = 4\text{mA}$
 $V_{CE} = 2\text{V}$
 $d = 1\text{mm}$



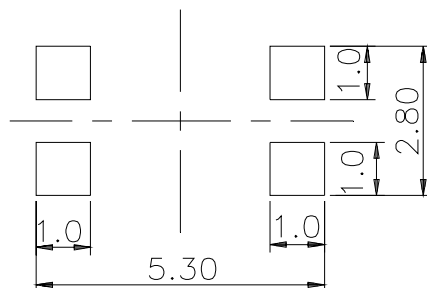
Reflow Soldering Profile For Lead-free SMT Process.



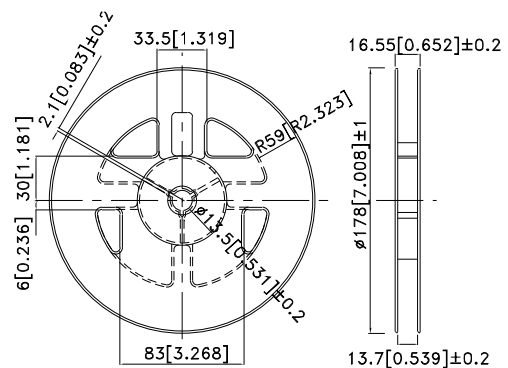
NOTES:

- 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3.Number of reflow process shall be 2 times or less.

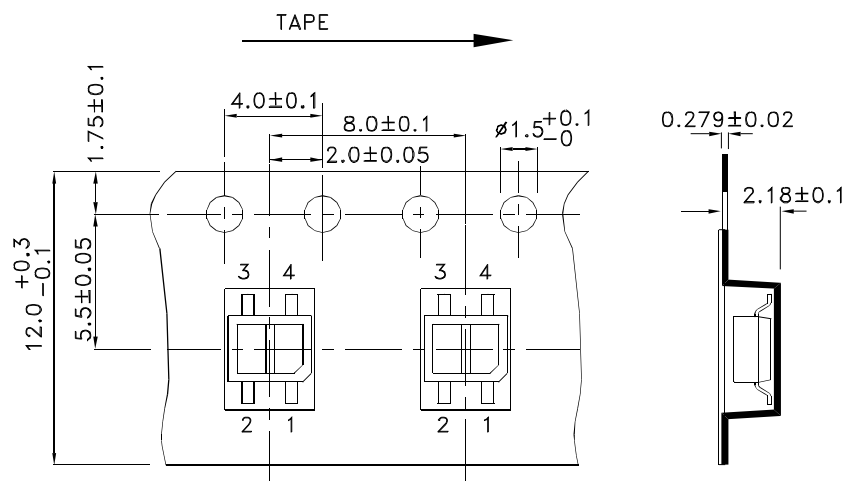
**Recommended Soldering Pattern
(Units : mm; Tolerance: ± 0.1)**



Reel Dimension

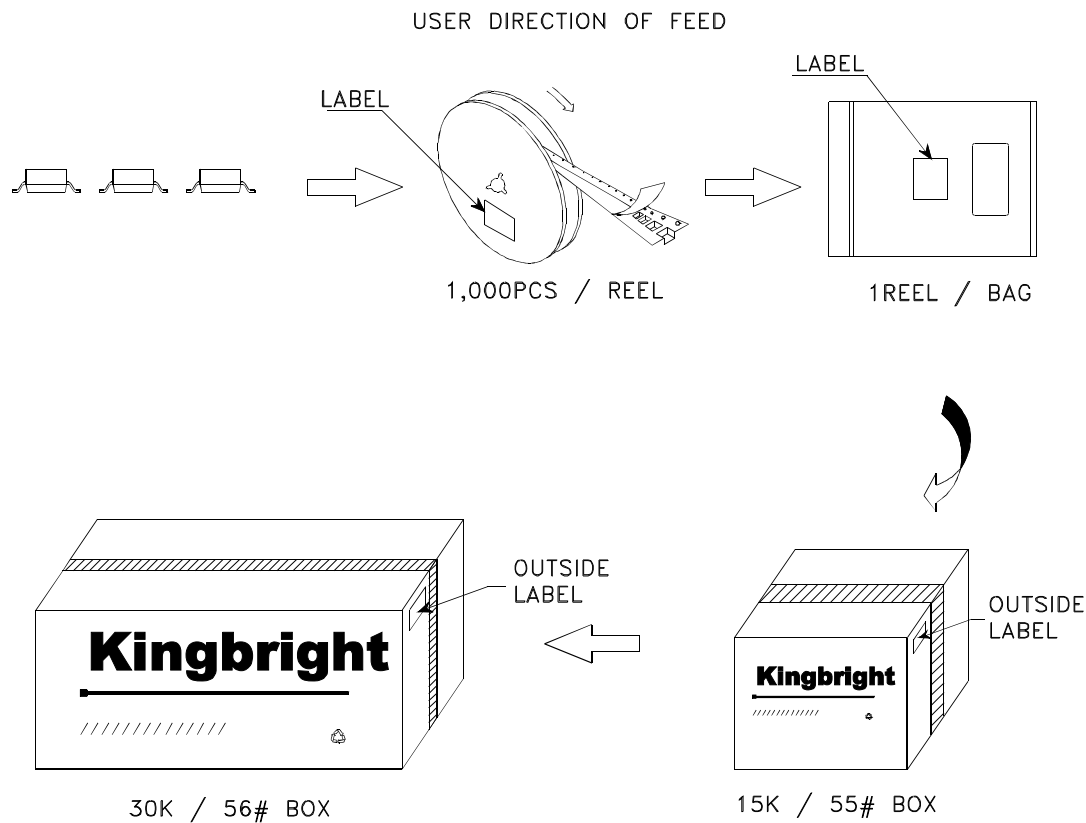


Tape Specifications (Units : mm)



PACKING & LABEL SPECIFICATIONS

KTIR0711S



Kingbright	
P/NO: KTIRXXX	
QTY: 1,000 pcs	Q.C.
S/N: XXXX	Q C xx xx xxxx
CODE: XXX	PASSED
LOT NO:	
	
XXXXXXXXXXXXXXXXXXXX	
RoHS Compliant	